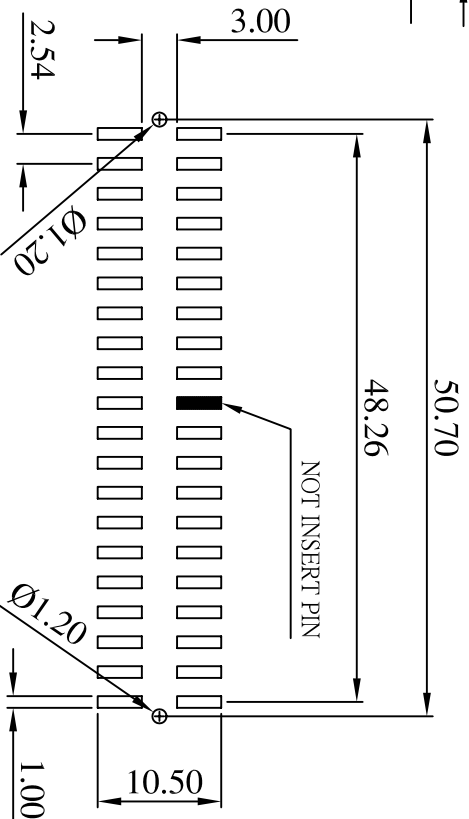
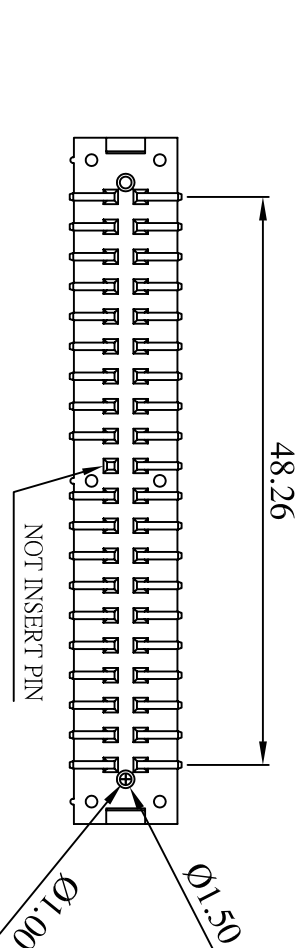


Recommended P.C. Board
SMD Layout

- Current Rating: 3 Amps
- Insulator Resistance: 5000 Megohms min
- Contact Resistance: 20m ohms max.
- Dielectric Withstanding: 1000V AC
- Operating Temperature: -40° ~ +105° C
- Max Processing Temp: 230° C for 60 seconds
- Contact Material: Copper Alloy
- Insulator Material: Polyester, UL 94V-0
- Finish: Tin, Gold Plated
- Standard: Nylon-6T
- Standard: Gold Flash all over



(RoHS Compliant)

BH11NX - 40 D1 BK X E01 X

1 2 3 4 5 6 7 8

1. Insulator Material:

N= Nylon-6T

2. A=Phosphor Bronze

B= Brass

1. Circuits: 40 pin

4. Taill Style:

D1= S.M.D with Peg

5. Color: BK=Black

6. Contact Plated:

T=Matte Tin over Nickel

W=Matte Tin over Nickel 150u"

Y=Bright Tin over Nickel

C=Gold Flash

F=Gold Flash, Matte Tin 100u"

A=Gold 3u"

B=Gold 3u", Matte Tin 100u"

7. E01=20 Not insert pin

8. Packing:

E=Gold 5u", Matte Tin 100u"

G=Gold 10u"

J=Gold 10u", Matte Tin 100u"

L=Gold 15u"

M=Gold 15u", Matte Tin 100u"

U=Gold 30u"

V=Gold 30u", Matte Tin 100u"



CONN TOP
COMPONENT INC.

PART NO

BH11NX-40D1BKXE01X

.X

±0.3

.XX

±0.20

.XXX

±0.100

1:

BH11N-40BKHI

DRAWING NO

BH-00112

EDITION: C1

ITEM: BH

BOM 2:

QT-0.64X12.80BN

DRAWN BY

GARY

2008/04/07

SCALE: 1:1

3:

0

APPROVAL BY

UNIT: m.m

TEL:(02)86481727 FAX:(02)86482427